

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	(analog with touch with panel and insulative and spacer and metal and thin and wires).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L2	1	10/538509	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L3	16	"4625075"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L4	10	"4504700"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L5	1381	345/174	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L6	0	2001EP-1102331.ap, prai.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L7	1	"1102331"	EPO	OR	ON	2008/12/12 16:21
L8	2	JP-01281622-\$.did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L9	0	anolog same resistive same (touch near panel)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21

L10	238	analog same resistive same (touch near panel)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L11	5	"6812065"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L12	5	("3624619" "4164622" "4208648").PN. OR ("4504700").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/12 16:21
L13	16	("3621268" "4198623" "4484179" "4504700" "4593191" "4609816" "4812833" "4837430" "5136156" "5266949" "5818037" "5887995").PN. OR ("6788295").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/12 16:21
L14	4	("20030067580" "5800175" "6965375").PN. OR ("7253808").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/12 16:21
L15	22	("3914021" "4432733" "5675397" "5760862" "5844175" "5888076" "5930663" "5990989" "6091474" "6191838" "6229695" "6506059" "6538709").PN. OR ("6965375").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/12 16:21
L16	169	analog same resistive and (touch near panel) and wire	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L17	8	("5854881" "6075520" "6124848").PN. OR ("6373474").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/12 16:21
L18	5	("20040251402" "5999279" "6043810" "6215477" "6370067").PN. OR ("7105752").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/12 16:21

L19	1	2002/0101410	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L20	3	"20020101410"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L21	4	"7034808"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L22	11258	345/173	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L23	1776591	wire	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L24	1815	L22 and L23	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L25	7866	analog same resistive	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L26	158	L24 and L25	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L27	361	(178/18.05).CCLS.	USPAT; USOCR	OR	OFF	2008/12/12 16:21
L28	200	wire with electrode with micrometer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L29	14	wire with electrode with (micrometer micron) same display	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21

L30	169	wire with electrode with (micrometer micron) and display	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L31	44	"5,844,506"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L32	90	"100" near (micron micrometer) near electrode	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L33	56	("100" "90" "80" "70" "60" "50" "40" "30") near (micron micrometer) near electrode and resist\$4 and display	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L34	328	("100" "90" "80" "70" "60" "50" "40" "30") near (micron micrometer) near diameter with electrode	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L35	109	("100" "90" "80" "70" "60" "50" "40" "30") near (micron micrometer) near diameter with electrode with wire	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L36	888	electrode with wire with (conduct\$3 with paste)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L37	3	L25 and L36	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L38	12	L22 and L36	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21

L39	484	("100" "90" "80" "70" "60" "50" "40" "30" "95" "85" "75" "65" "55" "45" "35") near (micron micrometer "μm") near20 electrode and resist\$4 and (conductive with (paste adhesive))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L40	9	("100" "90" "80" "70" "60" "50" "40" "30" "95" "85" "75" "65" "55" "45" "35") near (micron micrometer "μm") near20 electrode and resist\$4 and (conductive with (paste adhesive)) and (touch with panel)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L41	24	("100" "90" "80" "70" "60" "50" "40" "30" "95" "85" "75" "65" "55" "45" "35") near (micron micrometer "μm") near20 electrode and resist\$4 and (conductive with (paste adhesive)) and (touch with (panel screen surface pad))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L42	696915	("100" "90" "80" "70" "60" "50" "40" "30" "95" "85" "75" "65" "55" "45" "35") near (micron micrometer "μm") ((" .03" ".04" ".05" ".06" ".07" ".08" ".09" ".1") near (millimeter "mm"))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L43	20486	(L42 near10 (electrode wire))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L44	202118	(conduct\$3 with (paste adhesive glue cement bond epoxy))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21

L45	209339	(touch with (panel screen surface pad))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L46	4934	L44 and L45	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L47	109	L43 and L46	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L48	522	L43 and L45	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L49	23	("20020192441" "20030005955" "20030204038" "20040084080" "20040103936" "20040146560" "20040178390" "4865999" "4939050" "5571612" "6291763" "6414235" "6444296" "6472594" "6515218" "6517958" "6586764" "6706962" "6852920").PN. OR ("6936761").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/12 16:21
L50	12	("20020173354" "20030002273" "20040070335" "20040080267" "20040119403" "4683360" "4723080" "5450299" "5680160" "5947584").PN. OR ("7258469").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/12/12 16:21
L51	2197	wire with conductive with paste	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L52	48543	("345").CLAS.	USPAT; USOCR	OR	OFF	2008/12/12 16:21

L53	10	L51 and L52	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L54	3667	("100" "90" "80" "70" "60" "50" "40" "30" "95" "85" "75" "65" "55" "45" "35") near (micron micrometer "μm") near20 electrode and resist\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L55	70	L52 and L54	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L56	15388	(micron micrometer "μm") near5 electrode and resist\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L57	562	L52 and L56	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L58	155063	touch near10 (screen pad panel)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L59	271	L56 and L58	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L60	0	L52 near mm with (touch near panel)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L61	86	mm with (touch near panel) with (thin thick width)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L62	19439	((("0.1" ".1") near (mm milimeter)(micron micrometer "μm")) near5 electrode and resist\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21

L63	592	L52 and L62	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L64	30	L63 not L57	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L65	90	((("0.1" ".1") near (mm millimeter)(micron micrometer "µm")) near5 (electrode trace wire lead)and (resist\$4 with touch with (panel pad screen))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L66	1637	((("0.1" ".1") near (mm millimeter))(micron micrometer "µm")) near5 ((electrode trace wire lead)with copper)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L67	7	2001/0036504	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L68	2	"20010036504"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L69	155063	touch near10 (screen pad panel)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L70	158259	("100" "200") with micron	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L71	1562	L69 and L70	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L72	454885	ito	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21

L73	295	L69 and L70 and L72	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L74	4	extrode with external	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L75	103123	electrode with external	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L76	51	L69 and L70 and L75	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L77	2783437	electrode connector	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L78	1063	L69 and L70 and L77	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L79	3554	L70 with L77	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21
L80	22	L69 and L79	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/12/12 16:21

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